

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT3014957

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	PATENT RELEASE
CONVEYING PARTY DATA	
Name	Execution Date
CITIBANK, N.A.	09/09/2014
RECEIVING PARTY DATA	
Name:	FREESCALE SEMICONDUCTOR, INC.
Street Address:	6501 WILLIAM CANNON DRIVE WEST
City:	AUSTIN
State/Country:	TEXAS
Postal Code:	78735
PROPERTY NUMBERS Total: 5	
Property Type	Number
Patent Number:	6368924
Patent Number:	6576520
Patent Number:	6387787
Patent Number:	6580172
Patent Number:	6586160
CORRESPONDENCE DATA	
Fax Number:	(866)826-5420
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	301-638-0511
Email:	ipresearchplus@comcast.net
Correspondent Name:	IP RESEARCH PLUS, INC.
Address Line 1:	21 TADCASTER CIRCLE
Address Line 2:	ATTN: PENELOPE J.A. AGODOA
Address Line 4:	WALDORF, MARYLAND 20602
ATTORNEY DOCKET NUMBER:	CRS1-39723
NAME OF SUBMITTER:	PENELOPE J.A. AGODOA
SIGNATURE:	/pja/
DATE SIGNED:	09/09/2014
Total Attachments: 4 source=39723#page2.tif	

source=39723#page3.tif
source=39723#page4.tif
source=39723#page5.tif

PATENT RELEASE

THIS RELEASE is effective as of September 9, 2014 by Citibank, N.A., as Collateral Agent (as defined below) for the Lenders. Capitalized terms used herein and not otherwise defined shall have the meanings assigned to such terms in the Credit Agreement and IP Agreement, in each case, referred to below.

A. Reference is made to (i) the THIRD AMENDED AND RESTATED CREDIT AGREEMENT entered into as of March 1, 2013 (as otherwise amended, supplemented or modified from time to time, the “**Credit Agreement**”), among FREESCALE SEMICONDUCTOR, INC. (the “**Borrower**”), a Delaware corporation, FREESCALE SEMICONDUCTOR HOLDINGS V, INC. (“**Holdings**”), a Delaware corporation, FREESCALE SEMICONDUCTOR HOLDINGS IV, LTD., a Bermuda exempted limited liability company, FREESCALE SEMICONDUCTOR HOLDINGS III, LTD. (“**Parent**”), a Bermuda exempted limited liability company, CITIBANK, N.A., as administrative agent, collateral agent (in such capacity, the “**Collateral Agent**”), swing line lender and L/C issuer, and each lender from time to time party thereto (collectively, the “**Lenders**”); (ii) the INTELLECTUAL PROPERTY SECURITY AGREEMENT (as amended, supplemented or modified from time to time, the “**IP Agreement**”) dated as of December 1, 2006, among the Borrower, Holdings, the Subsidiaries of Parent from time to time party thereto and CITIBANK, N.A., as Collateral Agent; (iii) the PATENT SECURITY AGREEMENT (as amended, supplemented or modified from time to time, “**March Patent Agreement**”) dated as of March 12, 2008, among the Borrower and CITIBANK, N.A., as Collateral Agent; (iv) the PATENT SECURITY AGREEMENT (as amended, supplemented or modified from time to time, “**July Patent Agreement**”) dated as of July 28, 2008, among the Borrower and CITIBANK, N.A., as Collateral Agent; (v) the SUPPLEMENT NO. 4 (the “**Supplement**”) dated as of June 5, 2008, to the IP Agreement, among the Borrower, Holdings, the Subsidiaries of Parent and CITIBANK, N.A., as Collateral Agent; (vi) the SECURITY AGREEMENT dated as of December 1, 2006 among Freescale Acquisition Corporation, Freescale Semiconductor, Inc., Freescale Acquisition Holdings Corp., Freescale Holdings (Bermuda) IV, Ltd., the Subsidiaries of Freescale Holdings (Bermuda) III, Ltd. from time to time party thereto and Citibank, N.A. as Collateral Agent; and (vii) the other Collateral Documents (as defined in the Credit Agreement).

B. The IP Agreement was recorded in the Patent Division of the United States Patent and Trademark Office on February 2, 2007, at Reel 018855 and Frame 0129. The Supplement was recorded in the Patent Division of the United States Patent and Trademark Office on July 9, 2008, at Reel 021212 and Frame 0372. The March Patent Agreement was recorded in the Patent Division of the United States Patent and Trademark Office on July 11, 2008, at Reel 021217 and Frame 0368. The July Patent Agreement was recorded in the Patent Division of the United States Patent and Trademark Office on September 24, 2008, at Reel 021570 and Frame 0449.

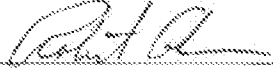
C. The Borrower has informed the Collateral Agent that it has disposed of the Patents listed on Schedule I attached hereto in a transaction permitted under the Credit Agreement.

Accordingly, the Collateral Agent's interest (including security interests) in and to the Patents listed on Schedule I attached hereto shall hereby terminate and the security interest recorded with the United States Patent & Trademark Office against such Patents shall hereby cease and become void.

[Remainder of page intentionally blank]

IN WITNESS WHEREOF, the Collateral Agent has caused this Release to be duly executed by its duly authorized officer.

CITIBANK, N.A., as Collateral Agent,

Signature: 

Print: Robert Cohen

Title: Vice President

Date: 9/9/2014

[Patent Release]

SCHEDULE I

I. Patents

Holder	Patent No.	Description/Title
FREESCALE SEMICONDUCTOR, INC.	6368924	AMORPHOUS CARBON LAYER FOR IMPROVED ADHESION OF PHOTORESIST AND METHOD OF FABRICATION
FREESCALE SEMICONDUCTOR, INC.	6576520	AMORPHOUS CARBON LAYER FOR IMPROVED ADHESION OF PHOTORESIST AND METHOD OF FABRICATION
FREESCALE SEMICONDUCTOR, INC.	6387787	LITHOGRAPHIC TEMPLATE AND METHOD OF FORMATION AND USE
FREESCALE SEMICONDUCTOR, INC.	6580172	LITHOGRAPHIC TEMPLATE AND METHOD OF FORMATION AND USE
FREESCALE SEMICONDUCTOR, INC.	6586160	METHOD FOR PATTERNING RESIST